

DATA SHEET

ACA0862B and ACA0862D: 1 GHz CATV Line Amplifier MMIC

Applications

- 50 to 1000 MHz 75 Ω amplifier
- HFC distribution systems
- CATV head-end equipment
- CATV line amplifier

Features

- 1 GHz specified performance
- Flat gain
- Very low distortion
- Excellent input/output match
- Low DC power consumption
- Good RF stability with high VSWR load conditions
- Surface-mount package compatible with automatic assembly
- Low cost
- Repeatability of monolithic fabrication
- Meets Cenelec standard
- RoHS-compliant packaging



Description

The ACA0862 family of surface-mount monolithic GaAs RF Linear Amplifiers has been developed to replace, in new designs, the standard CATV Hybrid amplifiers currently in use. The ACA0862 can also replace the ACA0861 with the addition of tuning capacitors to the output (see Figure 3). The MMICs consist of two parallel amplifiers, each with 12 dB gain. The amplifiers are optimized for exceptionally low distortion and noise figure while providing flat gain and excellent input and output return loss. The ACA0862B and ACA0862D are optimized for different output powers, and can be used separately or cascaded to support a variety of applications. A hybrid equivalent is formed when two ACA0862 devices are cascaded between transmission line baluns. For low-gain applications, a single ACA0862 can be used; for higher-gain applications, more than two can be cascaded. See the ACA0861 application note for more information.

A block diagram of the ACA0862 is shown in Figure 1. The device package and pinout are shown in Figure 2. Signal pin assignments and functional pin descriptions are described in Table 1.



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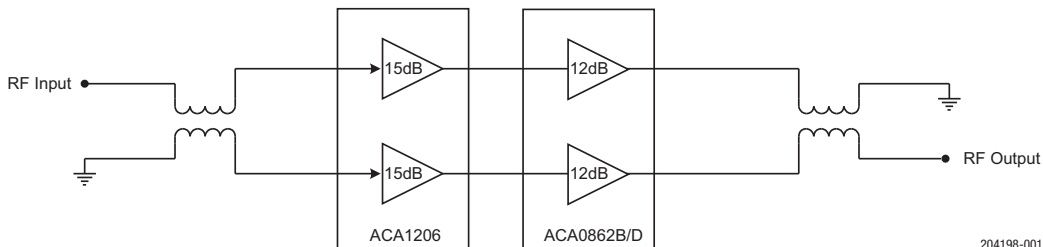


Figure 1. ACA0862 Block Diagram

Output Stages

The ACA0862B and ACA0862D are designed as output stage amplifiers. These parts can be used alone for low gain, high-output level applications or can be cascaded with an ACA1206 input stage amplifier for higher gain. The ACA0862B is a low-power dissipation part, while the ACA0862D is a high-power dissipation part.

The ACA1206 and ACA0862B can be cascaded to provide exceptional push-pull hybrid equivalent performance; an ACA1206 and an ACA0862D cascade provides exceptional power doubling hybrid equivalent performance. An ACA0862B can also be cascaded with an ACA0862D to create a power doubler with even better distortion performance.

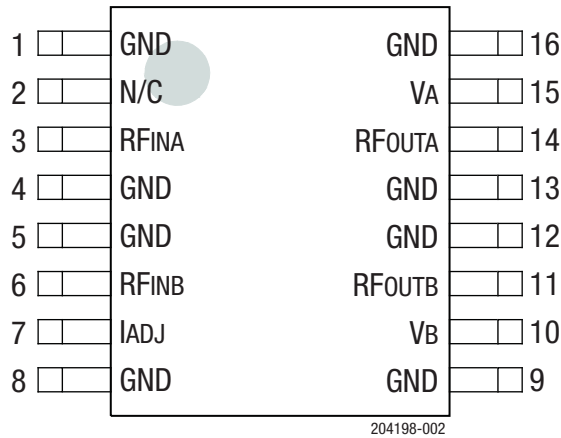


Figure 2. ACA0862 Pinout (Top View)

Table 1. ACA0862 Signal Pin Descriptions¹

Pin	Name	Description	Pin	Name	Description
1	GND	Ground	9	GND	Ground
2	N/C	No connection	10	VB	Supply for Amplifier B
3	RFINA	Input to Amplifier A	11	RFOUTB	Output from Amplifier B
4	GND	Ground	12	GND	Ground
5	GND	Ground	13	GND	Ground
6	RFINB	Input to Amplifier B	14	RFOUTA	Output from Amplifier A
7	IADJ	Current adjust	15	VA	Supply for Amplifier A
8	GND	Ground	16	GND	Ground

¹ The center ground pad must have a low inductance and low thermal resistance connection to the application's printed circuit board ground plane.

Electrical and Mechanical Specifications

The absolute maximum ratings of the ACA0862 are provided in Table 2. Recommended operating conditions are specified in Table 3, and electrical specifications are provided in Table 4.

Typical performance characteristics are shown in Figures 3 through 16.

Table 2. ACA0862 Absolute Maximum Ratings¹

Parameter	Minimum	Maximum	Units
Amplifier supplies (pins 10, 11, 14, and 15)	0	+15	VDC
RF input power (pins 3 and 6)		+70	dBmV
Storage temperature	-65	+150	°C
Soldering temperature		+260	°C
Soldering time		5.0	sec

¹ Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

² Pins 3 and 6 should be AC-coupled. No external DC bias should be applied.

³ Pin 7 must be terminated through a resistor to either VD or GND:

Part Number	Resistor (Pin 7)	Termination
ACA0862B	4.32K(R1)	GND
ACA0862D	9.09K(R2)	VD

Refer to Figure 17 (test circuit) and Table 6.

ESD HANDLING: *Although this device is designed to be as robust as possible, electrostatic discharge (ESD) can damage this device. This device must be protected at all times from ESD when handling or transporting. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD handling precautions should be used at all times.*

Table 3. ACA0862 Recommended Operating Conditions¹

Parameter	Symbol	Min	Typ	Max	Units
RF frequency	f	40		1000	MHz
Supply (pins 10, 11, 14, and 15)	V _D		+12		VDC
Operating temperature	T _A	-40		+110	°C

¹ Performance is guaranteed only under the conditions listed in this table.

Table 4. Electrical Specifications (TA = +25 °C, VD = +12 VDC)

Parameter	ACA0862B			ACA0862D			Unit
	Min	Typ	Max	Min	Typ	Max	
Gain ¹	10.7		11.7	10.8		11.8	dB
Gain flatness ¹			±0.3			±0.3	dB
Noise figure ¹		4	4.5		4	4.5	dB
CTB: ^{1, 2} 77 channels 110 channels			-70 -71		-81 -76	-78 -73	dBc dBc
CSO: ^{1, 2} 77 channels 110 channels			-68 -66		-71 -63	-68 -56	dBc dBc
XMOD: ^{1, 2} 77 channels 110 channels			-65 -68		-74 -74	-72 -71	dBc dBc
Supply current ³		395	445		530	610	mA
Cable equivalent slope ¹	-0.5		1.0	-0.5		1.0	dB
Return loss (input/output) ¹	18	22		18	22		dB
Thermal resistance (θ _{Jc})			6.0			6.0	°C/W

¹ Measured with a balun on input and output of the device. See Figure 3 for test setup.

² “B” device measured with 79 analog channels, +47 dBmV output power at 1002 MHz with a 3 dB tilt and QAM to 1002 MHz. “D” device measured with 79 analog channels, +56 dBmV output power at 1002 MHz with a 15.6 dB tilt and QAM to 1002 MHz. QAM channels are -6 dB relative to analog channels.

³ A fixed resistor is needed (see Table 6) to set the devices' current draw. Bias voltage is +12 VDC.

Typical Performance Characteristics

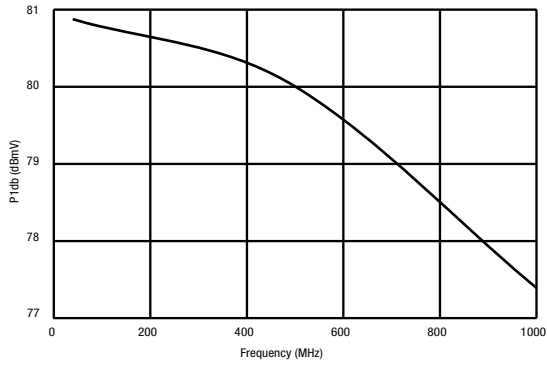


Figure 3. ACA0862B P1dB vs Frequency

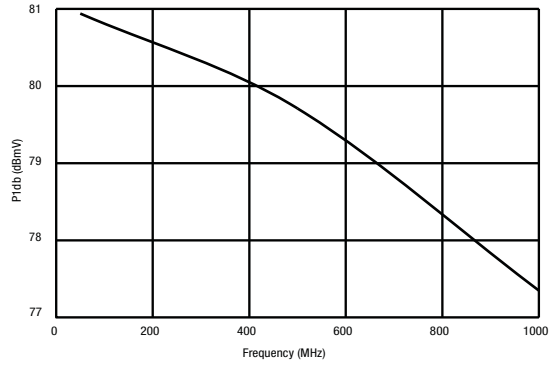


Figure 4. ACA0862D P1dB vs Frequency

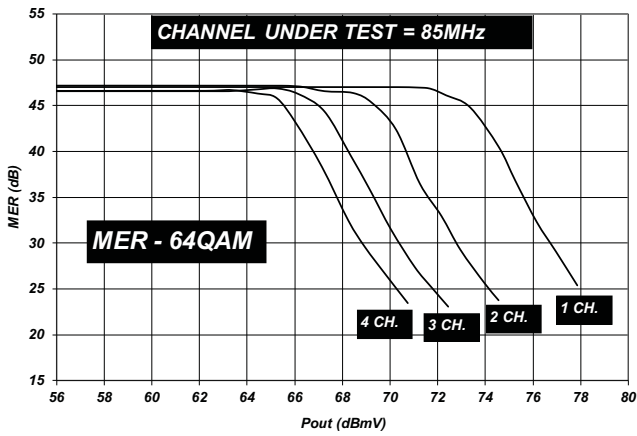


Figure 5. ACA0862B MER - 64 QAM @ 85 MHz

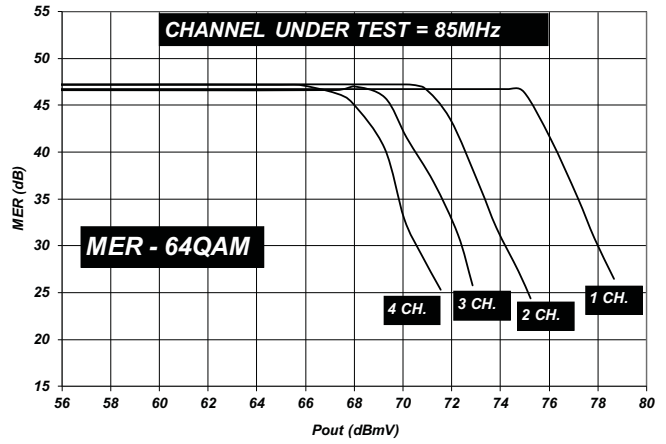


Figure 6. ACA0862D MER - 64 QAM @ 85 MHz

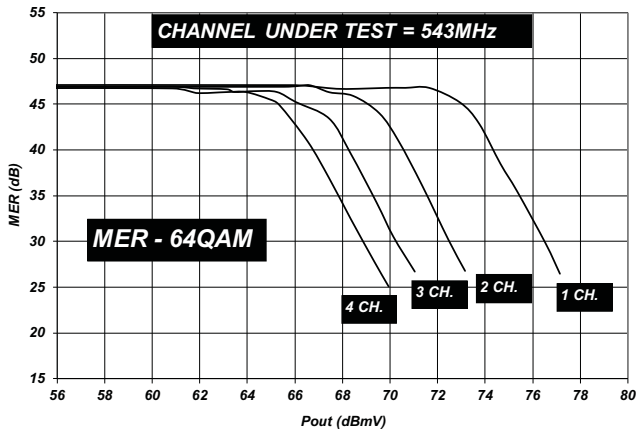


Figure 7. ACA0862B MER - 64 QAM @ 543 MHz

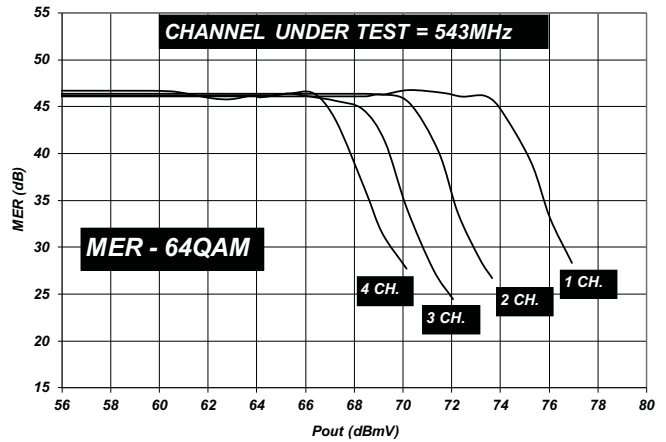


Figure 8. ACA0862D MER - 64 QAM @ 543 MHz

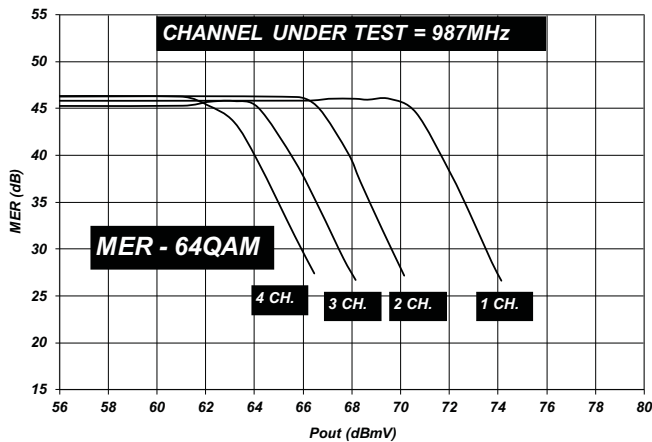


Figure 9. ACA0862B MER - 64 QAM @ 987 MHz

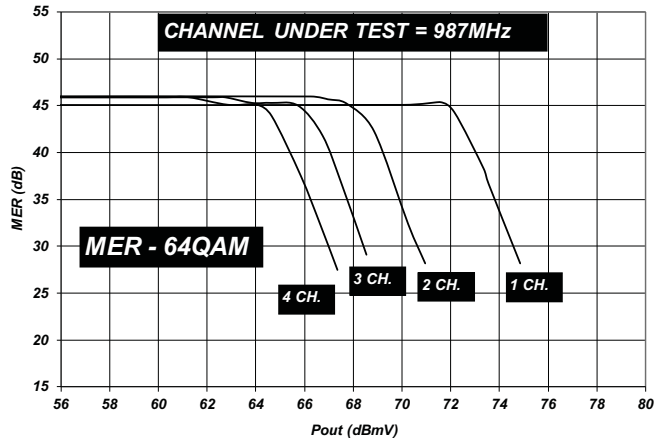


Figure 10. ACA0862D MER - 64 QAM @ 987 MHz

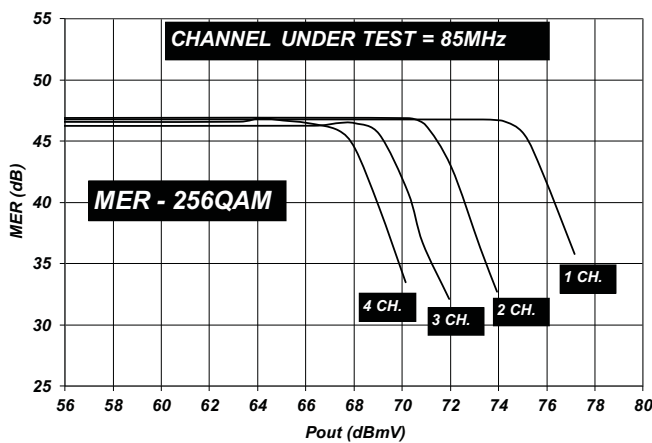


Figure 11. ACA0862B MER - 256 QAM @ 85 MHz

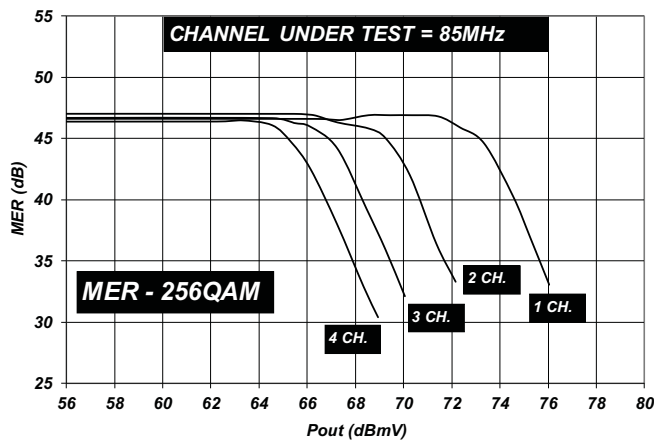


Figure 12. ACA0862D MER - 256 QAM @ 85 MHz

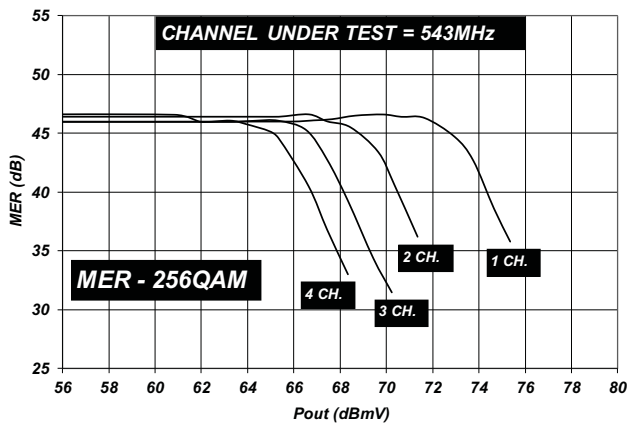


Figure 13. ACA0862B MER - 256 QAM @ 543 MHz

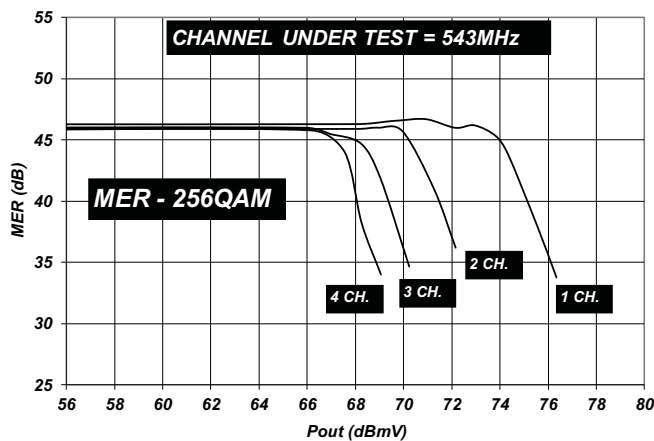


Figure 14. ACA0862D MER - 256 QAM @ 543 MHz

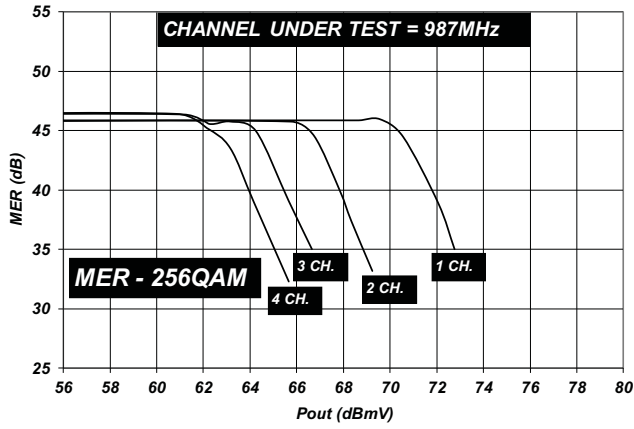


Figure 15. ACA0862B MER - 256 QAM @ 987 MHz

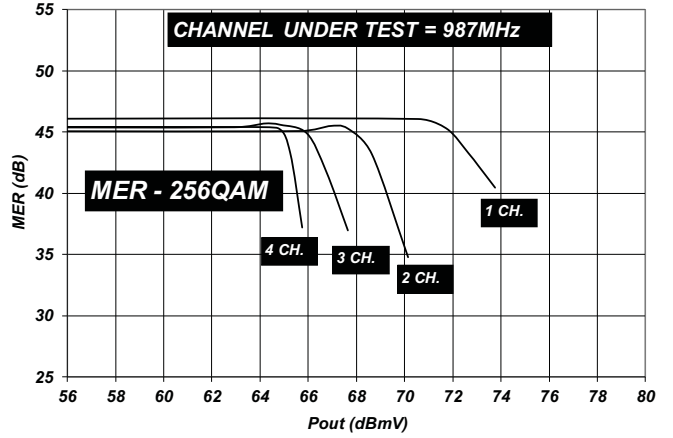
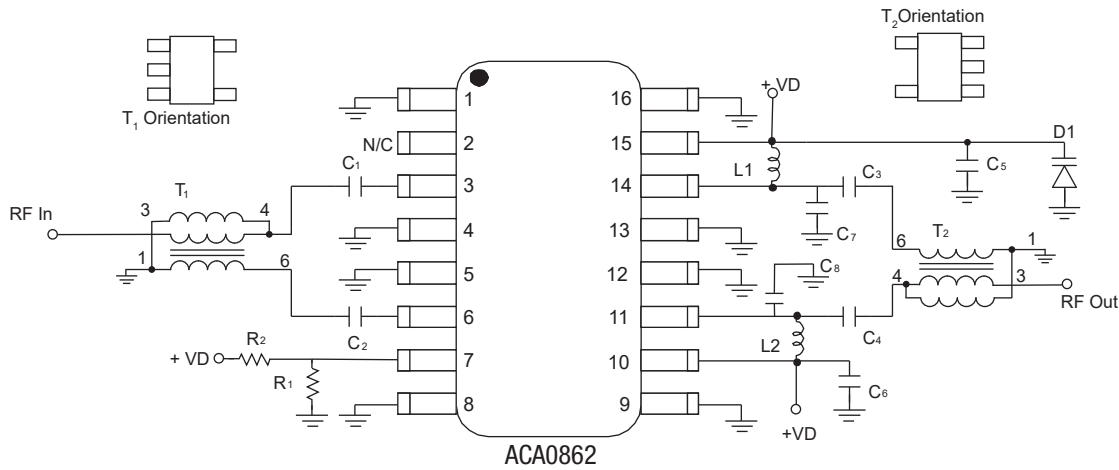


Figure 16. ACA0862D MER - 256 QAM @ 987 MHz

Evaluation Board Description

The ACA0862 Test Circuit Board is used to test the performance of the ACA0862 device. A Test Circuit schematic is provided in Figure 17. Table 5 provides the Bill of Materials (BOM) list for Test Circuit Board components.

Figure 18 shows the balun drawing. The hybrid equivalent test circuit schematic is shown in Figure 19.



Note: Apply voltage to both VD lines simultaneously.

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Figure 17. ACA0862 Test Circuit Board Schematic

Table 5. ACA0862 Test Circuit Board Bill of Materials (BOM)

Component	Description	Manufacturer	Mfr Part Number
C1, C2, C5, C6	0.01 uF chip capacitor	Murata	GRM39X7R103K25V
C3, C4	300 pF chip capacitor	Murata	GRM39X7R301K25V
C7, C8	1.5 pF chip capacitor	Murata	GRM1885C1H1R5C201B
L1, L2	390 nH air-wound chip conductor	Coilcraft	1008CS-391XJLC
R1	4.32 kΩ (ACA0862B) Open (ACA0862D)	Panasonic	ERJ-3EKF4321V
R2	Open (ACA0862B) 9.09 kΩ (ACA0862D)	Panasonic	ERJ-3EKF9091V
T1, T2	1:1 transmission line balun	Mintronix	MRF-25001
D1	TVS, 12 V, 600 W, unidirectional	LittleFuse, Inc.	SMBJ12A

Mechanical Specifications: Inch [mm]

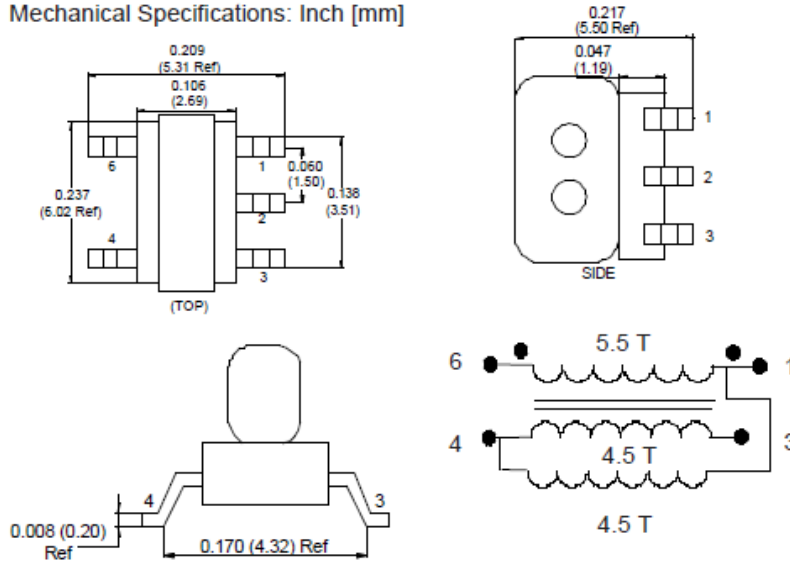
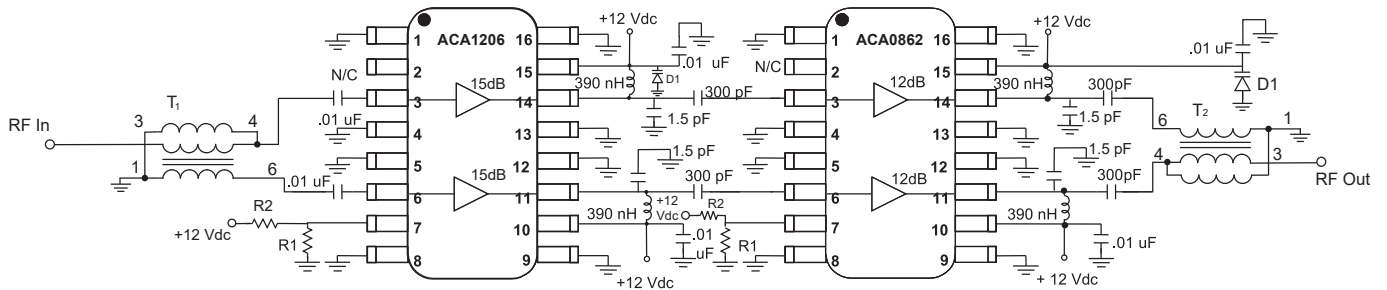


Figure 18. Balun Drawing



Notes:

1. Apply voltage to all +12 VDC lines simultaneously.
2. Refer to the BOM table for R1 and R2 values.

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Figure 19. ACA0862 Hybrid Equivalent Test Circuit Schematic

Package Dimensions

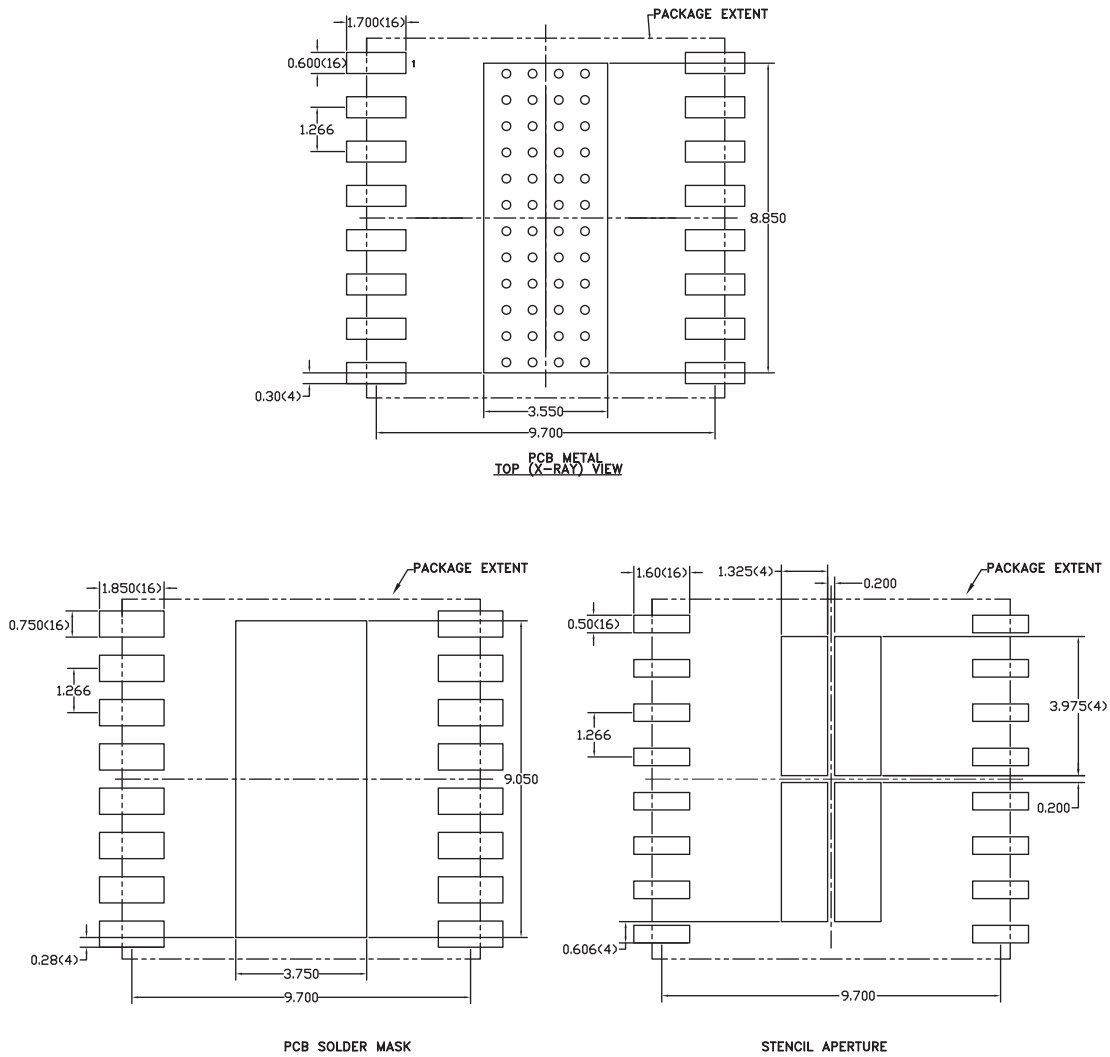
The PCB layout footprint drawing for the ACA0862 is shown in Figure 20. The package dimensions for the ACA0862 are shown in Figure 21. The tape and reel dimensions are provided in Figure 22.

Package and Handling Information

Since the device package is sensitive to moisture absorption, it is baked and vacuum packed before shipping. Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

The ACA0862 is rated to Moisture Sensitivity Level 2 (MSL2) at 260 °C. It can be used for lead or lead-free soldering. For additional information, refer to the Skyworks Application Note, *Solder Reflow Information*, document number 200164.

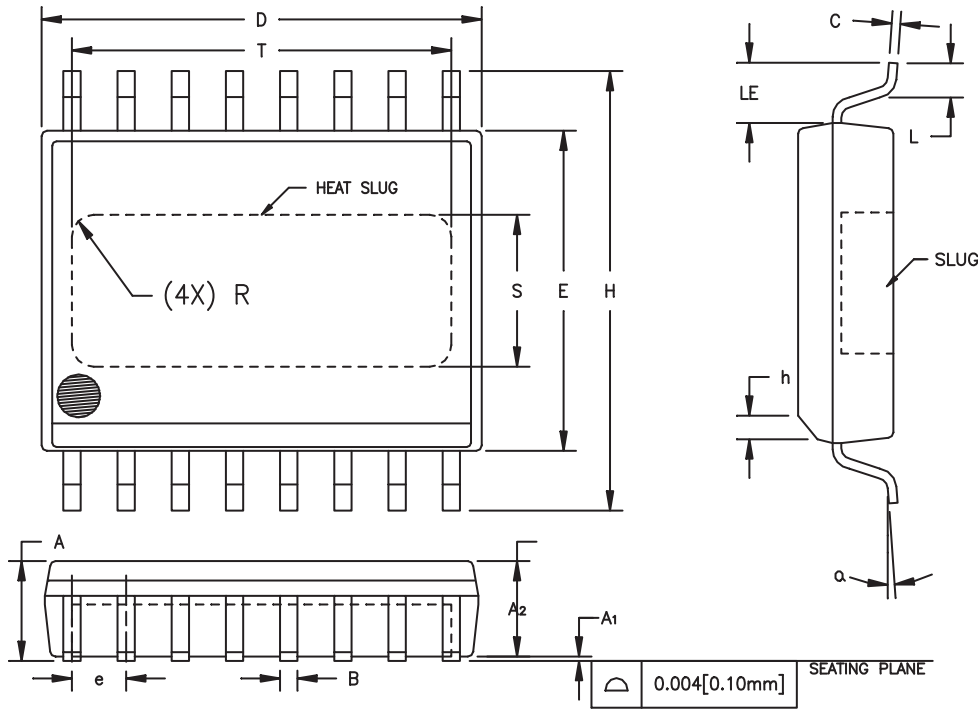
Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format.



- NOTES:**
- (1) UNLESS SPECIFIED DIMENSIONS ARE SYMMETRICAL ABOUT CENTER LINES SHOWN.
 - (2) DIMENSIONS IN MILLIMETERS.
 - (3) VIAS SHOWN IN PCB METAL VIEW ARE FOR REFERENCE ONLY. NUMBER & SIZE OF THERMAL VIAS REQUIRED DEPENDENT ON HEA DISSIPATION REQUIREMENT AND THE PC PROC SS CAPABILITY.
 - (4) RECOMMENDED STENCIL THICKNESS: APPROX. 0.125mm (5 Mils)

Figure 20. ACA0862 PCB Layout Footprint Dimensions

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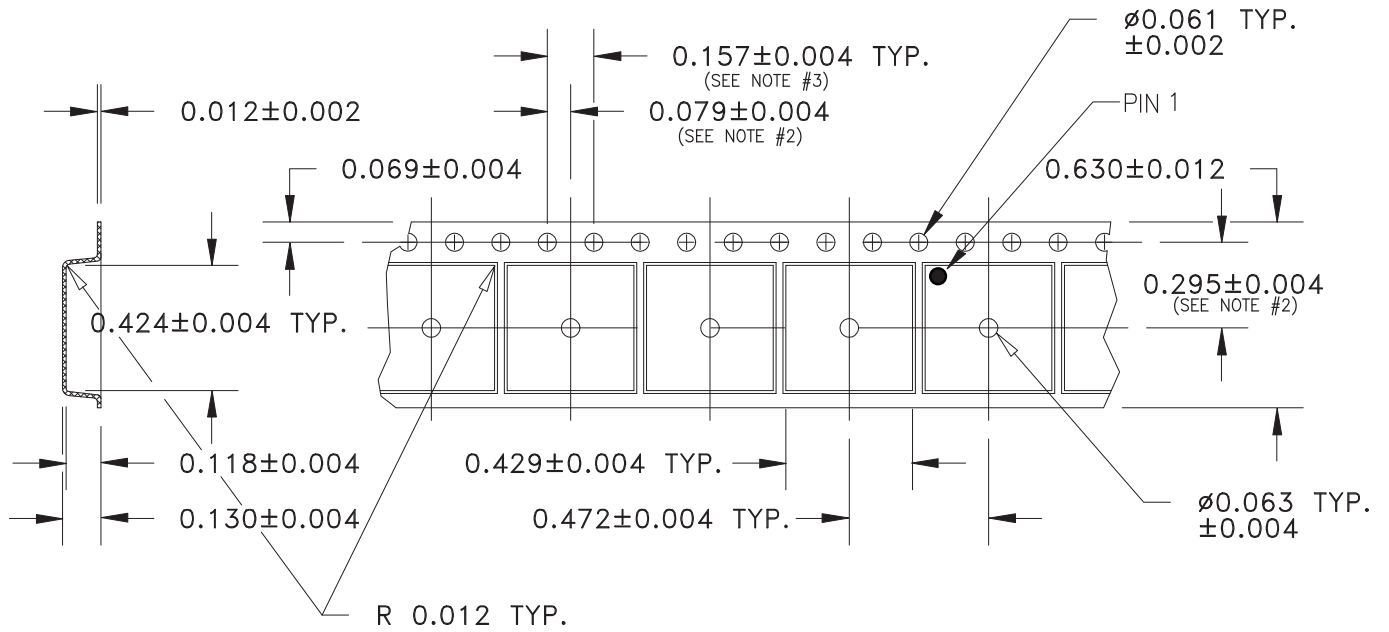


SYMBOL	INCHES		MILLIMETERS		NOTE
	MIN.	MAX.	MIN.	MAX.	
A	0.087	0.098	2.21	2.49	
A ₁	0.000	0.004	0.00	0.10	6
A ₂	0.087	0.094	2.21	2.39	
B	0.013	0.019	0.33	0.48	
C	0.007	0.009	0.18	0.23	
D	0.398	0.412	10.11	10.46	2
E	0.290	0.300	7.37	7.62	3
e	0.050	BSC	1.27	BSC	4
H	0.394	0.418	10.01	10.62	
h	0.010	0.028	0.25	0.71	
L	0.024	0.040	0.61	1.02	
LE	0.052	—	1.32	—	
alpha	0°	8°	0°	8°	
S	0.120	0.140	3.05	3.56	5
T	0.330	0.350	8.38	8.89	5
R	REF.	0.015	REF.	0.38	5

NOTES:

1. CONTROLLING DIMENSION: INCHES
2. DIMENSION "D" DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS AND GATE BURRS SHALL NOT EXCEED 0.006 [0.15mm] PER SIDE.
3. DIMENSION "E" DOES NOT INCLUDE INTER-LEAD FLASH OR PROTRUSIONS. INTER-LEAD FLASH AND PROTRUSIONS SHALL NOT EXCEED 0.010 [0.25mm] PER SIDE.
4. MAXIMUM LEAD TWIST/SKEW TO BE ±0.005 [0.13mm].
5. DIMENSIONS "S", "T" AND "R" INDICATE EXPOSED SLUG AREA.
6. STANDOFF HEIGHT (A₁) MEASURED FROM BOTTOM OF SLUG.

Figure 21. ACA0862 Package Dimensions



- NOTES: 1. MATERIAL - CONDUCTIVE POLYSTYRENE.
 2. MEASURED FROM CENTERLINE OF SPROCKET HOLE TO CENTERLINE OF POCKET.
 3. CUMULATIVE TOLERANCE OF 10 SPROCKET HOLES IS ± 0.008.

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Figure 22. ACA0862 Tape and Reel Dimensions

Ordering Information

Part Number	Package Description	Component Packaging
ACA0862BRS7P2	16-pin wide body SOIC with heat slug	1500-piece tape and reel
ACA0862DRS7P2	16-pin wide body SOIC with heat slug	1500-piece tape and reel

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